NTHL050N65S3HF

MOSFET – Power, N-Channel, SUPERFET III, FRFET

650 V, 58 A, 50 mΩ

Description

SUPERFET III MOSFET is ON Semiconductor's brand−new high voltage super−junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET is very suitable for the various power system for miniaturization and higher efficiency.

SUPERFET III FRFET MOSFET's optimized reverse recovery performance of body diode can remove additional component and improve system reliability.

Features

- 700 V @ T_J = 150°C
- Typ. $R_{DS(on)}$ = 41 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 125 nC)
- Low Effective Output Capacitance (Typ. $C_{oss(eff.)}$ = 1051 pF)
- 100% Avalanche Tested
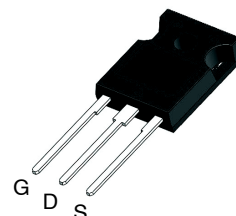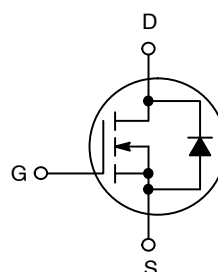- These Devices are Pb−Free and are RoHS Compliant

Applications

- Telecom / Server Power Supplies
- Industrial Power Supplies
- EV Charger
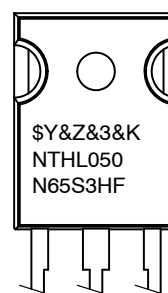- UPS / Solar

ON Semiconductor®

V_{DSS}	$R_{DS(ON)}$ MAX	I_D MAX
650 V	50 mΩ	58 A

TO−247 long leads
CASE 340CX

MARKING DIAGRAM


```
$Y&Z&3&K
NTHL050
N65S3HF
```

$Y	= ON Semiconductor Logo
&Z	= Assembly Plant Code
&3	= Data Code (Year & Week)
&K	= Lot
NTHL050N65S3HF	= Specific Device Code

ORDERING INFORMATION

NTHL050N65S3HF

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise noted)

Symbol	Parameter		Value	Unit
V_{DSS}	Drain to Source Voltage		650	V
V_{GSS}	Gate to Source Voltage	− DC	±30	V
		− AC (f > 1 Hz)	±30	
I_D	Drain Current	− Continuous (T_C = 25°C)	58	A
		− Continuous (T_C = 100°C)	37	
I_{DM}	Drain Current	− Pulsed (Note 1)	145	A
E_{AS}	Single Pulsed Avalanche Energy (Note 2)		830	mJ
I_{AS}	Avalanche Current (Note 2)		7.5	A
E_{AR}	Repetitive Avalanche Energy (Note 1)		3.78	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		50	
P_D	Power Dissipation	(T_C = 25°C)	378	W
		− Derate Above 25°C	3.03	W/°C
T_J, T_{STG}	Operating and Storage Temperature Range		−55 to +150	°C
T_L	Maximum Lead Temperature for Soldering, 1/8″ from Case for 5 seconds		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
1. Repetitive rating: pulse−width limited by maximum junction temperature.
2. I_{AS} = 7.5 A, R_G = 25 Ω, starting T_J = 25°C.
3. $I_{SD} \leq 29$ A, di/dt ≤ 200 A/μs, $V_{DD} \leq 400$ V, starting T_J = 25°C.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.33	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
NTHL050N65S3HF	NTHL050N65S3HF	TO−247	Tube	N/A	N/A	30 Units

NTHL050N65S3HF

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
OFF CHARACTERISTICS						
BV_{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	650	–	–	V
		V_{GS} = 0 V, I_D = 1 mA, T_J = 150°C	700	–	–	V
$\Delta BV_{DSS}/\Delta T_J$	Breakdown Voltage Temperature Coefficient	I_D = 15 mA, Referenced to 25°C	–	0.64	–	V/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 650 V, V_{GS} = 0 V	–	–	10	μA
		V_{DS} = 520 V, T_C = 125°C	–	73	–	
I_{GSS}	Gate to Body Leakage Current	V_{GS} = ±30 V, V_{DS} = 0 V	–	–	±100	nA
ON CHARACTERISTICS						
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = 1.7 mA	3.0	–	5.0	V
$R_{DS(on)}$	Static Drain to Source On Resistance	V_{GS} = 10 V, I_D = 29 A	–	41	50	mΩ
g_{FS}	Forward Transconductance	V_{DS} = 20 V, I_D = 29 A	–	36	–	S
DYNAMIC CHARACTERISTICS						
C_{iss}	Input Capacitance	V_{DS} = 400 V, V_{GS} = 0 V, f = 1 MHz	–	5017	–	pF
C_{oss}	Output Capacitance		–	110	–	pF
$C_{oss(eff.)}$	Effective Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	–	1051	–	pF
$C_{oss(er.)}$	Energy Related Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	–	200	–	pF
$Q_{g(tot)}$	Total Gate Charge at 10V	V_{DS} = 400 V, I_D = 29 A, V_{GS} = 10 V (Note 4)	–	125	–	nC
Q_{gs}	Gate to Source Gate Charge		–	37	–	nC
Q_{gd}	Gate to Drain "Miller" Charge		–	49	–	nC
ESR	Equivalent Series Resistance	f = 1 MHz	–	1.7	–	Ω
SWITCHING CHARACTERISTICS						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 400 V, I_D = 29 A, V_{GS} = 10 V, R_g = 2.2 Ω (Note 4)	–	34	–	ns
t_r	Turn-On Rise Time		–	31	–	ns
$t_{d(off)}$	Turn-Off Delay Time		–	91	–	ns
t_f	Turn-Off Fall Time		–	25	–	ns
SOURCE-DRAIN DIODE CHARACTERISTICS						
I_S	Maximum Continuous Source to Drain Diode Forward Current		–	–	58	A
I_{SM}	Maximum Pulsed Source to Drain Diode Forward Current		–	–	145	A
V_{SD}	Source to Drain Diode Forward Voltage	V_{GS} = 0 V, I_{SD} = 29 A	–	–	1.3	V
t_{rr}	Reverse Recovery Time	V_{GS} = 0 V, I_{SD} = 29 A, dI_F/dt = 100 A/μs	–	141	–	ns
Q_{rr}	Reverse Recovery Charge		–	688	–	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Essentially independent of operating temperature typical characteristics.
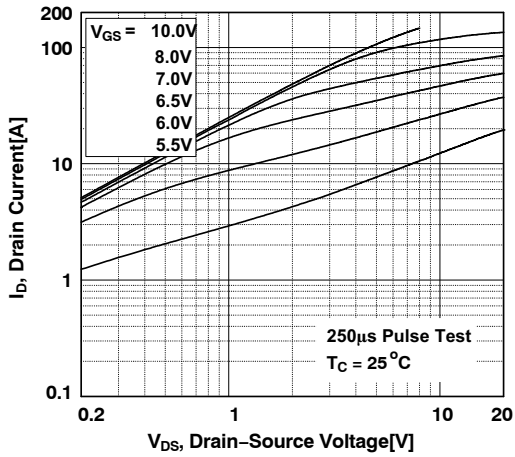
TYPICAL CHARACTERISTICS
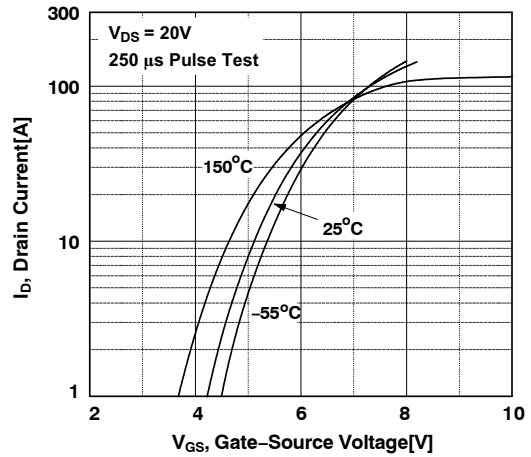

Figure 1. On−Region Characteristics

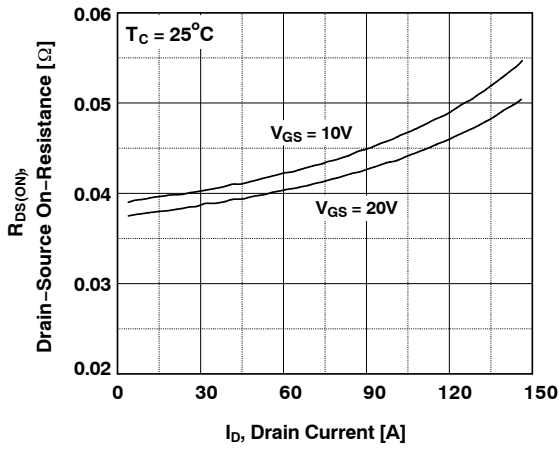**Figure 2. Transfer Characteristics**

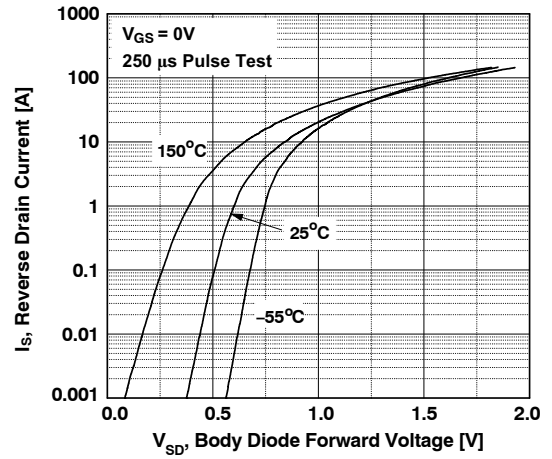**Figure 3. On−Resistance Variation vs. Drain Current and Gate Voltage**

Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature
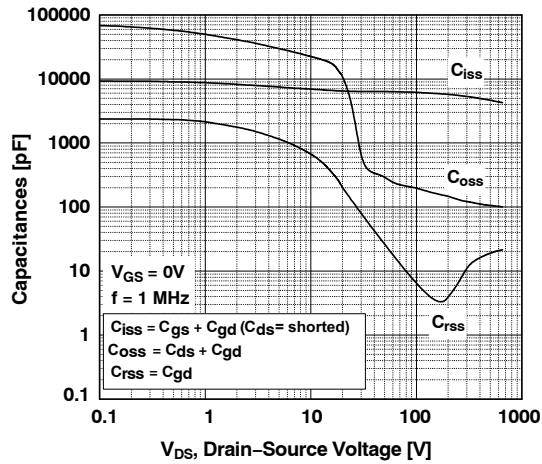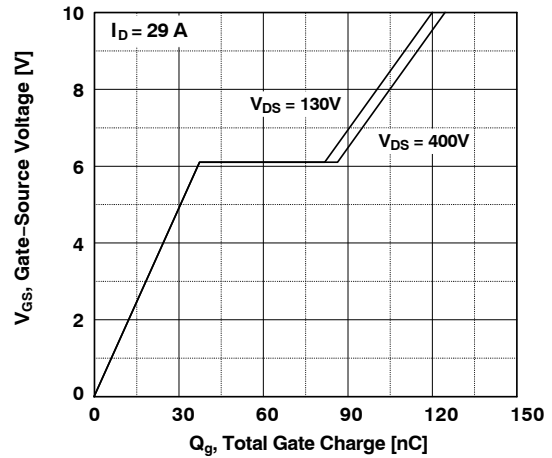

Figure 5. Capacitance Characteristics

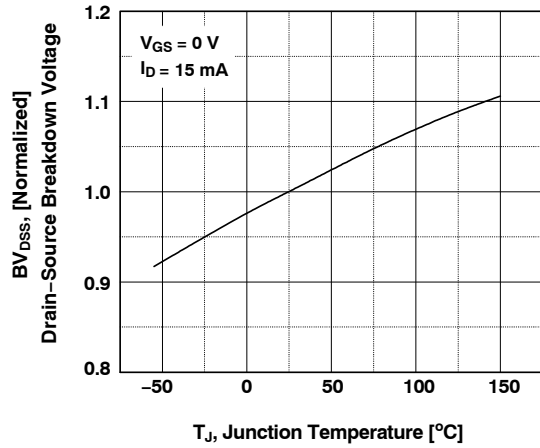**Figure 6. Gate Charge Characteristics**

TYPICAL CHARACTERISTICS
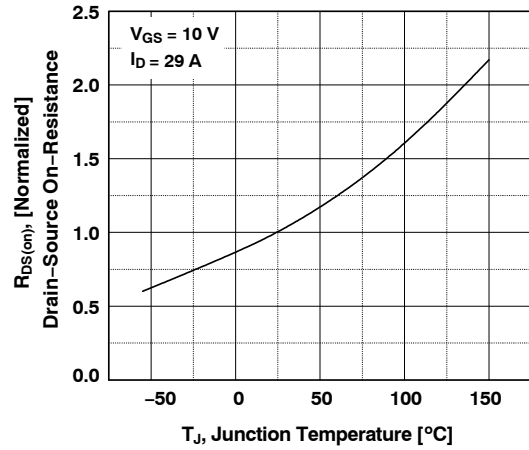
Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On−Resistance Variation vs. Temperature
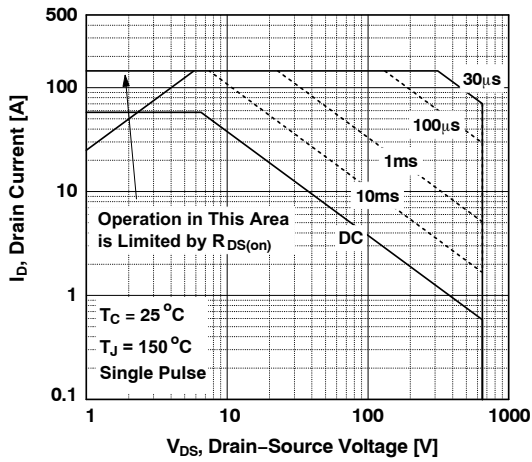
Figure 9. Maximum Safe Operating Area
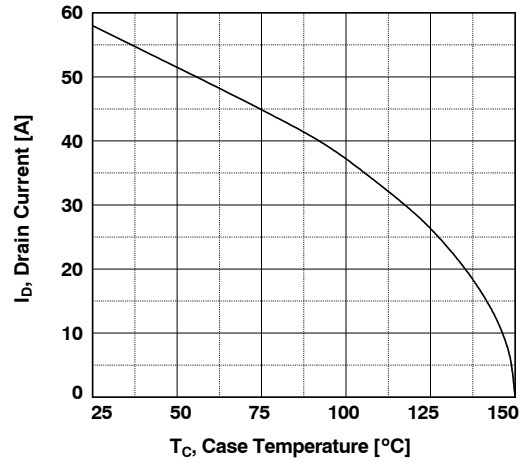
Figure 10. Maximum Drain Current vs. Case Temperature
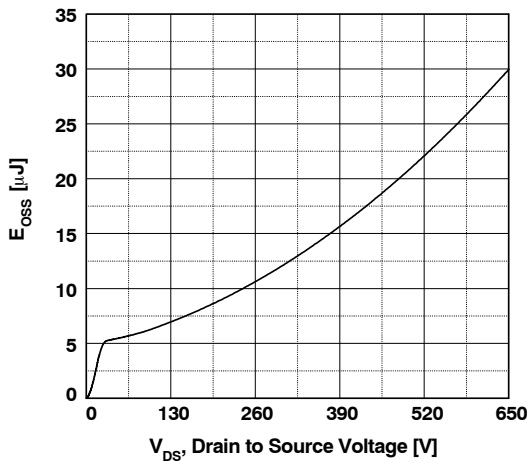
Figure 11. Eoss vs. Drain−to−Source Voltage

TYPICAL CHARACTERISTICS
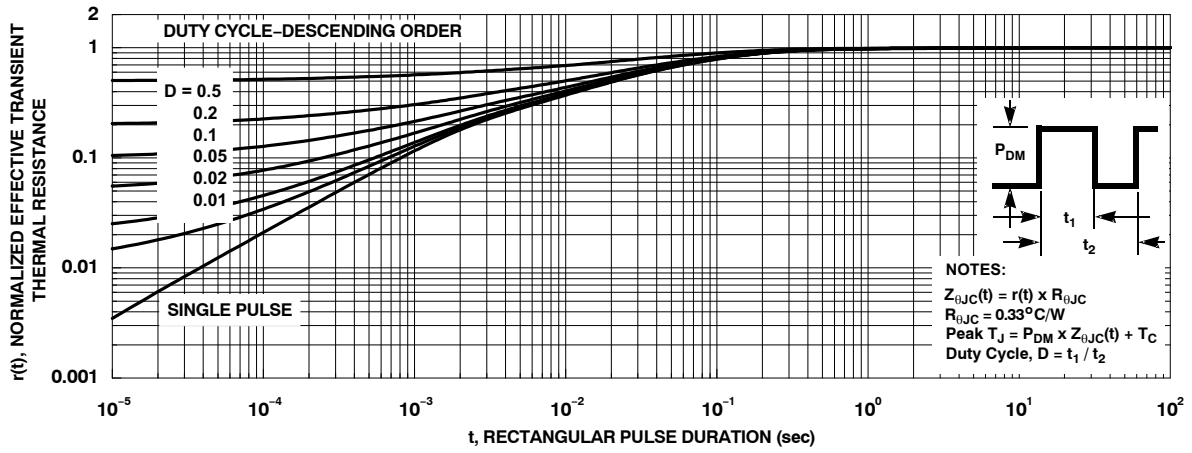
Figure 12. Transient Thermal Response Curve
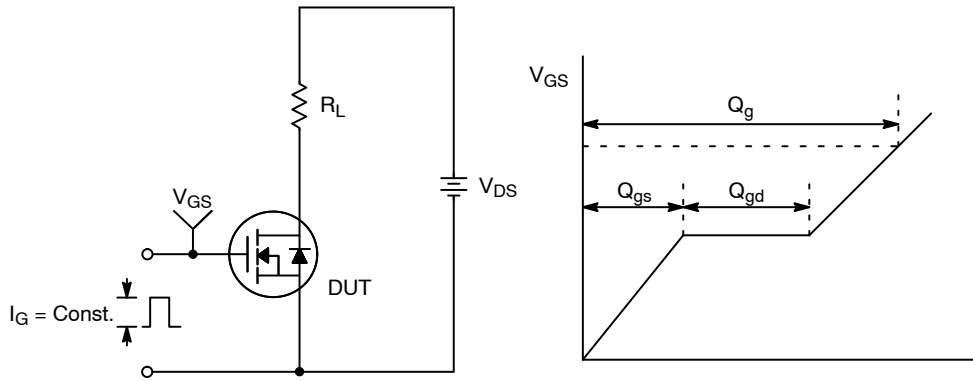
Figure 13. Gate Charge Test Circuit & Waveform
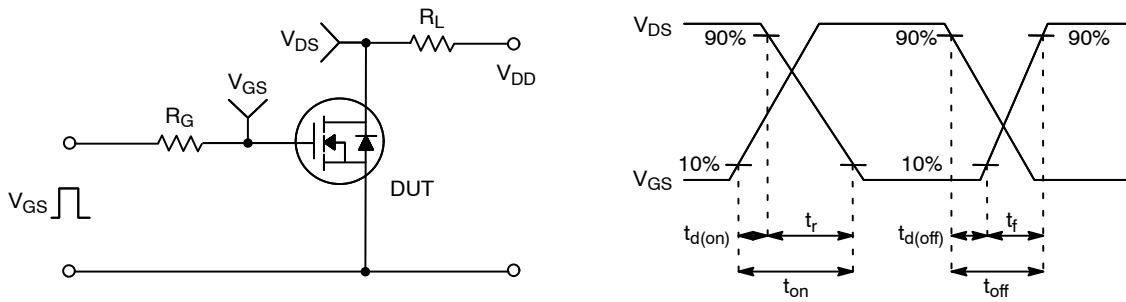
Figure 14. Resistive Switching Test Circuit & Waveforms

$$E_{AS} = \frac{1}{2} \cdot LI_{AS}^{2}$$
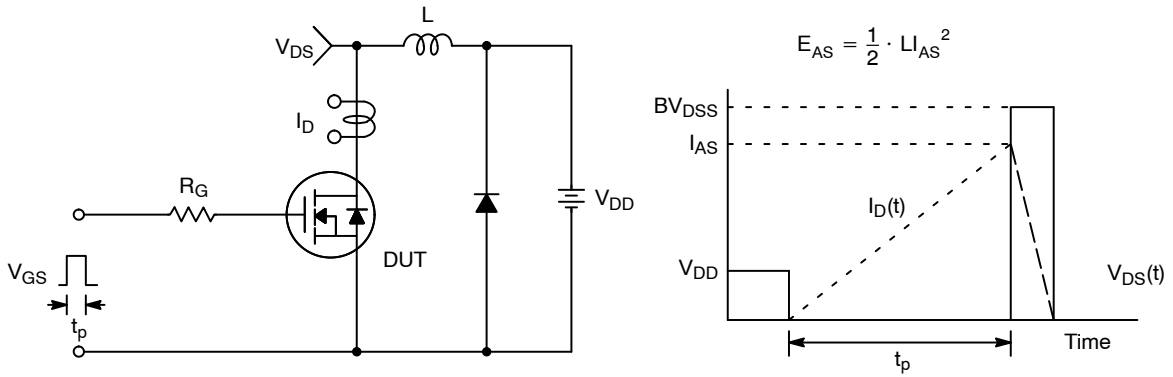
Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

$$D = \frac{\text{Gate Pulse Width}}{\text{Gate Pulse Period}}$$
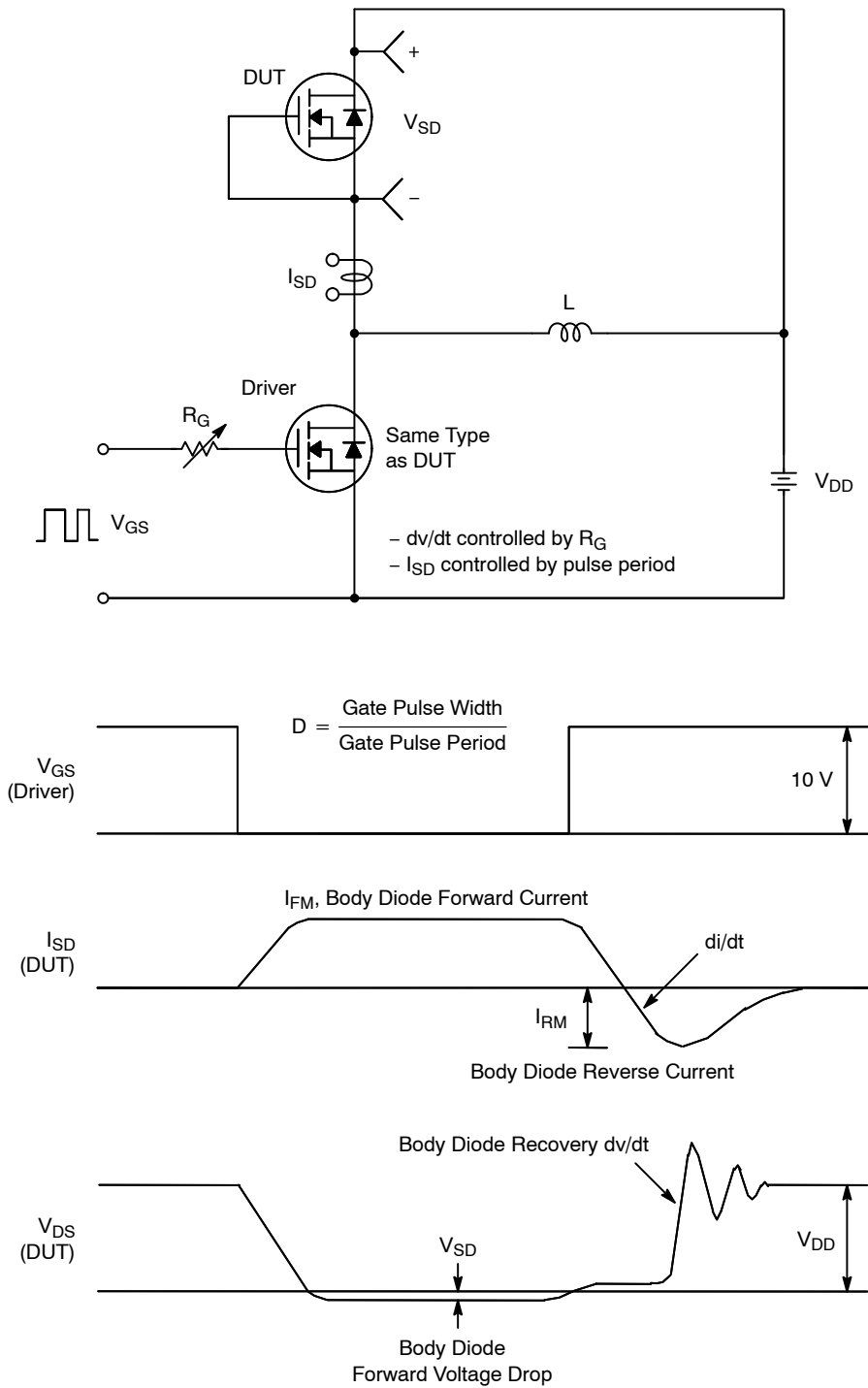
Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

TO−247−3LD
CASE 340CX
ISSUE A

DATE 06 JUL 2020

NOTES: UNLESS OTHERWISE SPECIFIED.

A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
B. ALL DIMENSIONS ARE IN MILLIMETERS.
C. DRAWING CONFORMS TO ASME Y14.5 - 2009.
D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC MARKING DIAGRAM*

XXXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, "G" or microdot " ▪", may or may not be present. Some products may not follow the Generic Marking.

DIM	MILLIMETERS		
	MIN	NOM	MAX
A	4.58	4.70	4.82
A1	2.20	2.40	2.60
A2	1.40	1.50	1.60
D	20.32	20.57	20.82
E	15.37	15.62	15.87
E2	4.96	5.08	5.20
e	~	5.56	~
L	19.75	20.00	20.25
L1	3.69	3.81	3.93
⌀P	3.51	3.58	3.65
Q	5.34	5.46	5.58
S	5.34	5.46	5.58
b	1.17	1.26	1.35
b2	1.53	1.65	1.77
b4	2.42	2.54	2.66
c	0.51	0.61	0.71
D1	13.08	~	~
D2	0.51	0.93	1.35
E1	12.81	~	~
⌀P1	6.60	6.80	7.00

DOCUMENT NUMBER:	98AON93302G		
DESCRIPTION:	TO−247−3LD		PAGE 1 OF 1

PUBLICATION ORDERING INFORMATION

◊

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